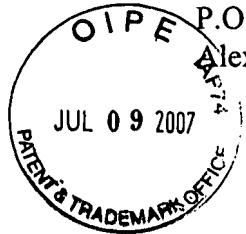


1765

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
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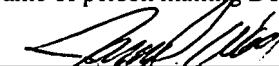


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(Date of Deposit)

James D. Wood

Name of person mailing Document or Fee

A handwritten signature of James D. Wood.

Signature

July 5, 2007

Date of Signature

Re: Application of: Charles E. May  
Serial No.: 09/943,196  
Filed: August 30, 2001  
For: Arrangement and Method for Fabricating A  
Semiconductor Wafer  
Group Art Unit: 1765  
Examiner: Lynette T. Umez-Eronini  
Our Docket No.: 1003-0606

**TRANSMITTAL OF RESPONSE TO OFFICE ACTION**

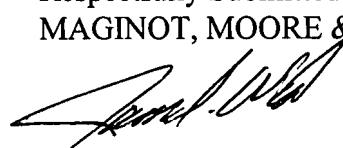
Please find for filing in connection with the above patent application the following:

1. Response to Office Action; and
2. One (1) return post card.

\* The fee has been calculated as shown below.

CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest No. Paid For	Fee Calculation	Addit Fee
Total Claims	15	20	0 X 50	\$ 0.00
Independent Claims	3	3	0 X 200	\$ 0.00
Total Additional Fee Required				\$ 0.00

Respectfully Submitted,  
MAGINOT, MOORE & BECK LLP



James D. Wood  
Registration No. 43,285  
Chase Tower  
111 Monument Circle, Suite 3250  
Indianapolis, Indiana 46204-5109

July 5, 2007

Enclosures



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

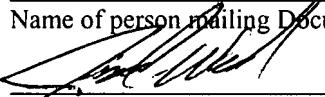
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Examiner: Lynette T. Umez-Eronini  
Confirmation No.: 8500  
Our Docket No.: 01-146/RCE (1003-0606)

**RESPONSE TO OFFICE ACTION**

Sir:

In response to the Office Action dated April 5, 2007, please enter the following:

**Amendments to the claims** begin on page 2 of this paper; and

**Remarks/Arguments** begin on page 7 of this paper.